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# **Peak EMI Reducing Solution**

#### **Features**

- Generates an EMI optimized clock signal at the output.
- Integrated loop filter components.
- Operates with a 3.3 / 2.5V Supply.
- Operating current less than 5mA.
- CMOS design.
- Input frequency range: 30MHz to 50MHz for 2.5V
   30MHz to 50MHz for 3.3V
- Generates a 1X low EMI spread spectrum clock of the input frequency.
- Frequency deviation: ±0.75% (Typ) @ 46MHz Input Frequency.
- Available in 6L-TSOP (6L-TSOT-23) Package.

#### **Product Description**

The ASM3P2780A is a versatile spread spectrum frequency modulator designed specifically for a wide range of clock frequencies. The ASM3P2780A reduces electromagnetic interference (EMI) at the clock source, allowing system wide reduction of EMI of all clock dependent signals. The ASM3P2780A allows significant system cost savings by reducing the number of circuit board layers, ferrite beads and shielding that are traditionally required to pass EMI regulations.

The ASM3P2780A uses the most efficient and optimized modulation profile approved by the FCC and is implemented by using a proprietary all digital method.

The ASM3P2780A modulates the output of a single PLL in order to "spread" the bandwidth of a synthesized clock, and more importantly, decreases the peak amplitudes of its harmonics. This results in significantly lower system EMI compared to the typical narrow band signal produced by oscillators and most frequency generators. Lowering EMI by increasing a signal's bandwidth is called 'spread spectrum clock generation.'

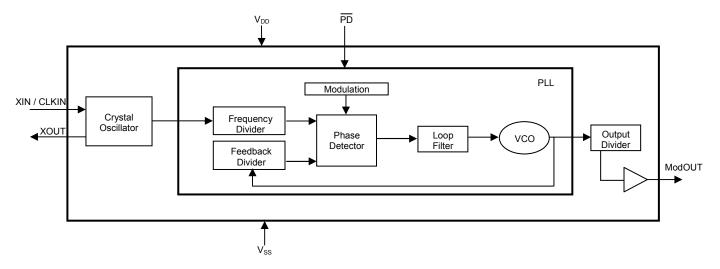
#### **Applications**

The ASM3P2780A is targeted towards all portable devices like MP3 players and digital still cameras.

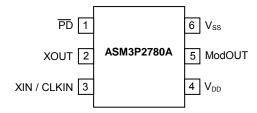
#### **Key Specifications**

Troy openineations	
Description	Specification
Supply voltages	V <sub>DD</sub> = 3.3V / 2.5V
Cycle-to-Cycle Jitter	±200pS (Typ)
Output Duty Cycle	45/55%
Modulation Rate Equation	F <sub>IN</sub> /1280
Frequency Deviation	±0.75 (Typ) @ 46MHz

#### **Block Diagram**



# Pin Configuration (6L-TSOP Package)



### **Pin Description**

Pin#	Pin Name	Туре	Description				
1	 PD	I	Power-down control pin. Pull low to enable power-down mode. Connect to V <sub>DD</sub> if not used.				
2	XOUT	0	Crystal connection. If using an external reference, this pin must be left unconnected.				
3	XIN / CLKIN	I	Crystal connection or external reference frequency input. This pin has dual functions. It can be connected either to an external crystal or an external reference clock.				
4	$V_{DD}$	Р	Power supply for the entire chip.				
5	ModOUT	0	Spread spectrum clock output.				
6	V <sub>SS</sub>	Р	Ground connection.				

**Specifications** 

оресписация				
Description		Specification		
	For 2.5V Supply			
Frequency Range	For 3.3V Supply	30MHz < CLKIN < 50MHz		
Modulation Equation		F <sub>IN</sub> /1280		
Frequency Deviation		±0.75% (Typ) @ 46MHz		

**Absolute Maximum Ratings** 

Symbol	Parameter	Rating	Unit				
$V_{DD},V_{IN}$	Voltage on any pin with respect to Ground	-0.5 to +4.6	V				
T <sub>STG</sub>	Storage temperature	-65 to +125	$\mathcal{C}$				
Ts	Max. Soldering Temperature (10 sec)	260	С				
TJ	Junction Temperature	150	C				
$T_DV$	Static Discharge Voltage (As per JEDEC STD22- A114-B)	2	KV				
	Note: These are stress ratings only and are not implied for functional use. Exposure to absolute maximum ratings for prolonged periods of time may affect device reliability.						

**Operating Conditions** 

Parameter	Description	Min	Max	Unit
VDD	Supply Voltage	2.375	3.6	V
$T_A$	Operating Temperature (Ambient Temperature)	-40	+85	က
$C_L$	Load Capacitance		15	pF
$C_{IN}$	Input Capacitance		7	pF

**DC Electrical Characteristics for 2.5V Supply** 

Symbol	Parameter	Min	Тур	Max	Unit
V <sub>IL</sub>	Input low voltage	V <sub>SS</sub> -0.3		0.8	V
V <sub>IH</sub>	Input high voltage	2.0		V <sub>DD</sub> +0.3	V
I <sub>IL</sub>	Input low current			-35	μA
I <sub>IH</sub>	Input high current			35	μA
I <sub>XOL</sub>	XOUT output low current (@ 0.6V, V <sub>DD</sub> = 2.5V)		3		mA
I <sub>XOH</sub>	XOUT output high current (@ 1.8V, V <sub>DD</sub> = 2.5V)		3		mA
V <sub>OL</sub>	Output low voltage (V <sub>DD</sub> = 2.5 V, I <sub>OL</sub> = 8mA)			0.6	V
V <sub>OH</sub>	Output high voltage (V <sub>DD</sub> = 2.5 V, I <sub>OH</sub> = 8mA)	1.8			V
I <sub>DD</sub>	Static supply current <sup>1</sup>			10	uA
Icc	Dynamic supply current (2.5V, 46MHz and no load)		4.0		mA
$V_{DD}$	Operating Voltage	2.375	2.5	2.625	V
ton	Power-up time (first locked cycle after power-up) <sup>2</sup>			5	mS
Z <sub>OUT</sub>	Output impedance		50		Ω
	CLKIN pin and PD pin are pulled low. and XIN / CLKIN input are stable, PD pin is made high from low.			•	

**AC Electrical Characteristics for 2.5V Supply** 

Input frequency Output frequency		30		50	MHz
Output frequency		30			
		30		50	MHz
Francisco Daviation	Input Frequency = 30MHz		±1.10		0/
Frequency Deviation Input Frequency = 50MHz			±0.65		%
Output rise time (measured from 0.7V to 1.7V)		0.7	1.3	1.6	nS
Output fall time (measured from 1.7V to 0.7V)		0.4	8.0	1.0	nS
Jitter (cycle-to-cycle)			±200		pS
Output duty cycle		45	50	55	%
Ji C	utput fall time (measured frotter (cycle-to-cycle)	utput rise time (measured from 0.7V to 1.7V) utput fall time (measured from 1.7V to 0.7V) tter (cycle-to-cycle) utput duty cycle	utput rise time (measured from 0.7V to 1.7V)  utput fall time (measured from 1.7V to 0.7V)  tter (cycle-to-cycle)  utput duty cycle  45	utput rise time (measured from 0.7V to 1.7V) 0.7 1.3 utput fall time (measured from 1.7V to 0.7V) 0.4 0.8 tter (cycle-to-cycle) ±200	utput rise time (measured from 0.7V to 1.7V) 0.7 1.3 1.6 utput fall time (measured from 1.7V to 0.7V) 0.4 0.8 1.0 tter (cycle-to-cycle) ±200

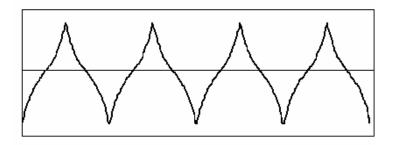
**DC Electrical Characteristics for 3.3V Supply** 

Symbol	Parameter	Min	Тур	Max	Unit
V <sub>IL</sub>	Input low voltage	V <sub>SS</sub> -0.3		0.8	V
V <sub>IH</sub>	Input high voltage	2.0		V <sub>DD</sub> +0.3	V
I <sub>IL</sub>	Input low current			-35	μA
I <sub>IH</sub>	Input high current			35	μΑ
I <sub>XOL</sub>	XOUT output low current (@ 0.4V, V <sub>DD</sub> = 3.3V)		3		mA
I <sub>XOH</sub>	XOUT output high current (@ 2.5V, V <sub>DD</sub> = 3.3V)		3		mA
V <sub>OL</sub>	Output low voltage (V <sub>DD</sub> = 3.3 V, I <sub>OL</sub> = 8mA)			0.4	V
V <sub>OH</sub>	Output high voltage (V <sub>DD</sub> = 3.3 V, I <sub>OH</sub> = 8mA)	2.5			V
I <sub>DD</sub>	Static supply current <sup>1</sup>			10	uA
Icc	Dynamic supply current (3.3V, 46MHz and no load)		5.0		mA
$V_{DD}$	Operating Voltage	2.7	3.3	3.6	V
ton	Power-up time (first locked cycle after power-up) <sup>2</sup>			5	mS
Z <sub>out</sub>	Output impedance		45		Ω
	/ CLKIN pin and PD pin are pulled low. and XIN / CLKIN input are stable, PD pin is made high from low.	•			•

**AC Electrical Characteristics for 3.3V Supply** 

Symbol	Pa	Parameter			Max	Unit
CLKIN	Input frequency	Input frequency			50	MHz
ModOUT	Output frequency	Output frequency			50	MHz
· f	Fraguency Deviation	Input Frequency = 30MHz		±1.10		%
f <sub>d</sub>	Frequency Deviation	Input Frequency = 50MHz		±0.65		%
t <sub>LH</sub> <sup>1</sup>	Output rise time (measure	Output rise time (measured from 0.8 to 2.0V)		1.1	1.4	nS
t <sub>HL</sub> 1	Output fall time (measure	Output fall time (measured at 2.0V to 0.8V)		0.8	1.1	nS
t <sub>JC</sub>	Jitter (cycle-to-cycle)	Jitter (cycle-to-cycle)		±200		pS
t <sub>D</sub>	Output duty cycle		45	50	55	%
Note: 1. t <sub>LH</sub> and t <sub>HL</sub> are me	Note: 1. t <sub>LH</sub> and t <sub>HL</sub> are measured into a capacitive load of 15pF.					

## **Modulation Profile**

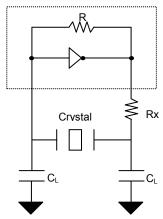


# **Typical Crystal Specifications**

Fundamental AT cut parallel resonant crystal				
Nominal frequency	33MHz			
Frequency tolerance	± 50 ppm or better at 25℃			
Operating temperature range	-25℃ to +85℃			
Storage temperature	-40℃ to +85℃			
Load capacitance(C <sub>P</sub> )	18pF			
Shunt capacitance	7pF maximum			
ESR	25 Ω			

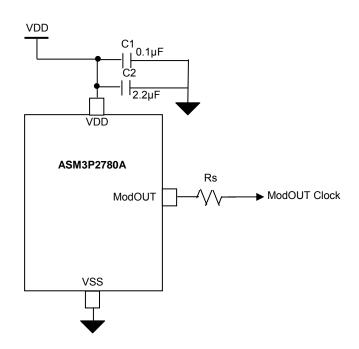
Note: Note: C<sub>L</sub> is Load Capacitance and Rx is used to prevent oscillations at overtone frequency of the Fundamental frequency.

### **Typical Crystal Interface Circuit**



$$\begin{split} C_\text{L} &= 2^*(C_\text{P} - C_\text{S}),\\ \text{Where } C_\text{P} &= \text{Load capacitance of crystal}\\ C_\text{S} &= \text{Stray capacitance due to } C_\text{IN,} \text{ PCB, Trace etc.} \end{split}$$

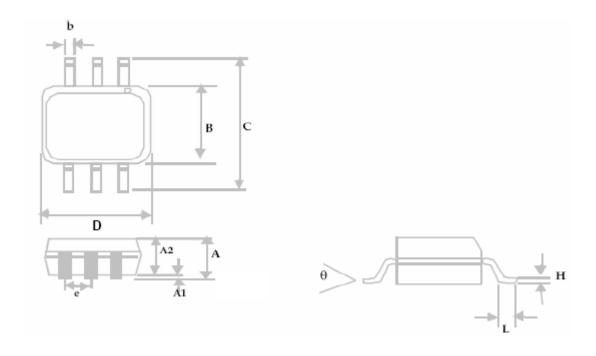
# **Typical Application Schematic**



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# **Package Information**

# **6L-TSOP Package**



	Dimensions				
Symbol	Inches		Milli	meters	
	Min	Max	Min	Max	
Α		0.04		1.00	
A1	0.00	0.004	0.00	0.10	
A2	0.033	0.036	0.84	0.90	
b	0.012	0.02	0.30	0.50	
Н	0.005 BSC		0.127 BSC		
D	0.114 BSC 2.90 BSC		0 BSC		
В	0.06 BSC		1.60 BSC		
е	0.0374 BSC		0.950 BSC		
С	0.11 BSC		2.8	0 BSC	
L	0.0118	0.02	0.30	0.50	
θ	0°	4°	0°	4°	

**Ordering Information** 

Part Number	Marking	Package Type	Temperature
ASM3P2780AF-06OR	G4L	6L-TSOP (6L-TSOT-23), TAPE & REEL, Pb Free	0℃ to +70℃

A "microdot" placed at the end of last row of marking or just below the last row toward the center of package indicates Pb-free.

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